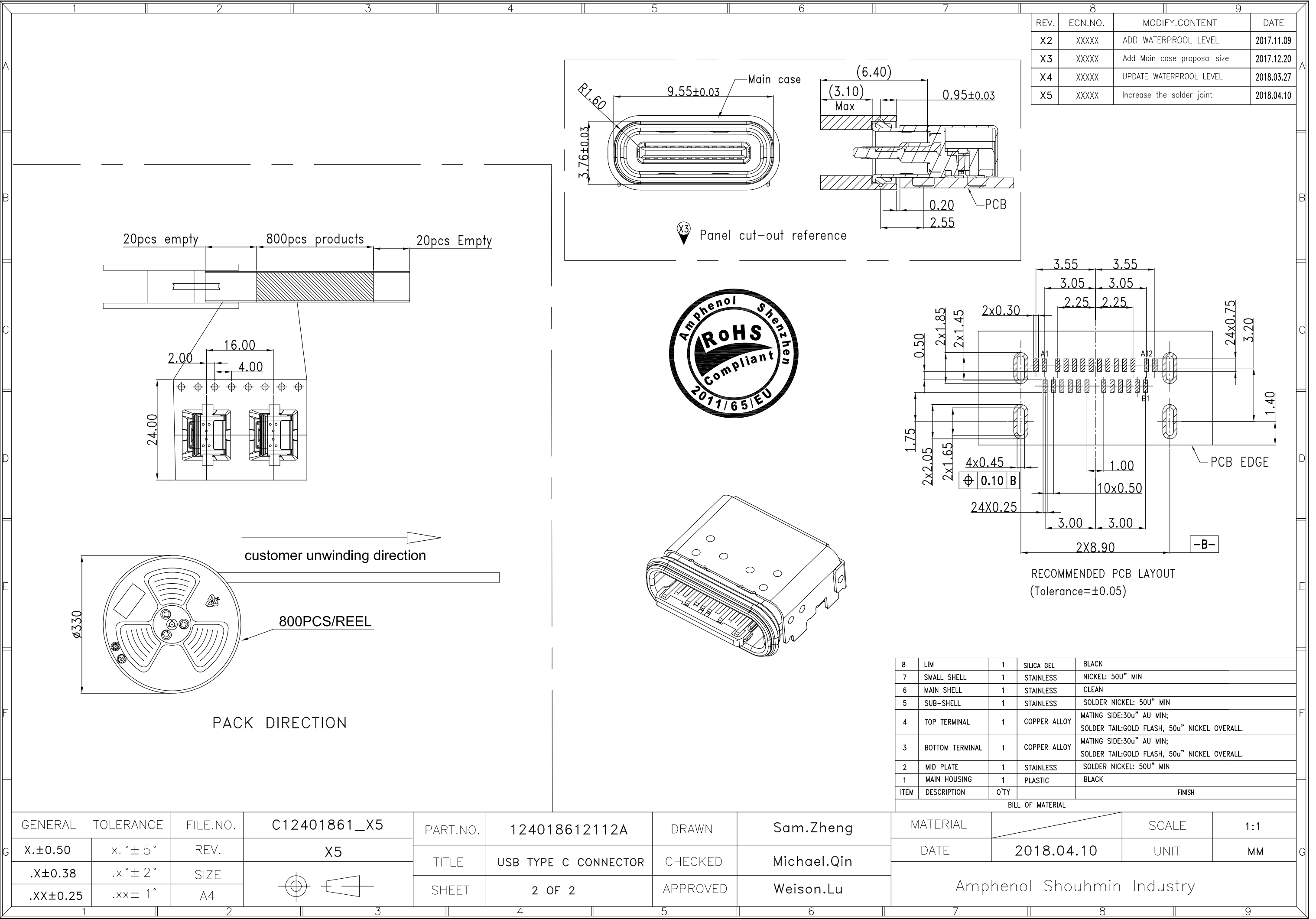
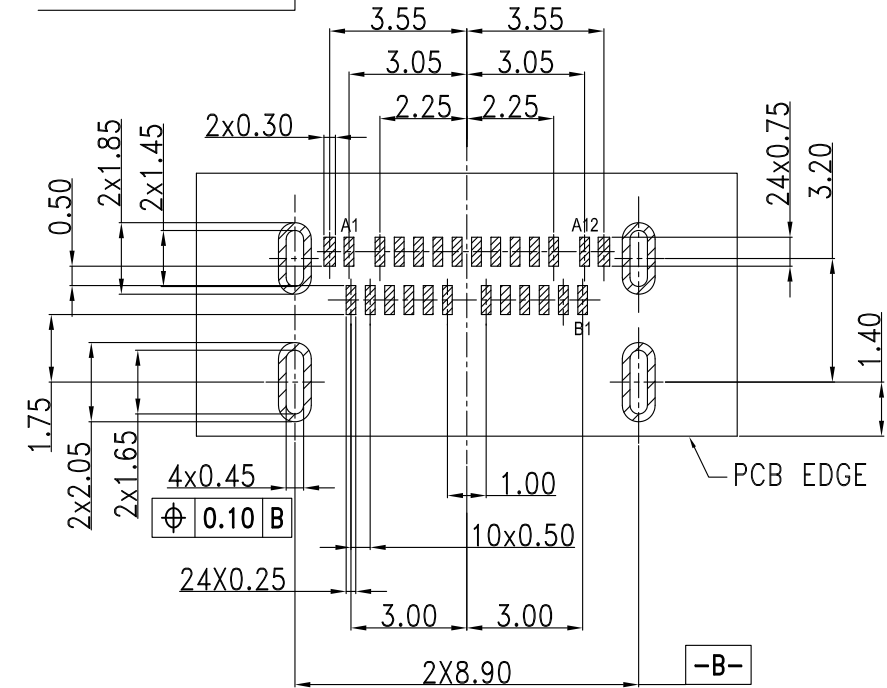




REV.	ECN.NO.	MODIFY.CONTENT	DATE
X2	XXXXX	ADD WATERPROOF LEVEL	2017.11.09
X3	XXXXX	Add Main case proposal size	2017.12.20
X4	XXXXX	UPDATE WATERPROOF LEVEL	2018.03.27
X5	XXXXX	Increase the solder joint	2018.04.10



RECOMMENDED PCB LAYOUT
(Tolerance=±0.05)

8	LIM	1	SILICA GEL	BLACK
7	SMALL SHELL	1	STAINLESS	NICKEL: 50U" MIN
6	MAIN SHELL	1	STAINLESS	CLEAN
5	SUB-SHELL	1	STAINLESS	SOLDER NICKEL: 50U" MIN
4	TOP TERMINAL	1	COPPER ALLOY	MATING SIDE:30u" AU MIN; SOLDER TAIL:GOLD FLASH, 50u" NICKEL OVERALL.
3	BOTTOM TERMINAL	1	COPPER ALLOY	MATING SIDE:30u" AU MIN; SOLDER TAIL:GOLD FLASH, 50u" NICKEL OVERALL.
2	MID PLATE	1	STAINLESS	SOLDER NICKEL: 50U" MIN
1	MAIN HOUSING	1	PLASTIC	BLACK
ITEM	DESCRIPTION	Q'TY	FINISH	

BILL OF MATERIAL

GENERAL	TOLERANCE	FILE.NO.	C12401861_X5	PART.NO.	124018612112A	DRAWN	Sam.Zheng
X.±0.50	x. °± 5°	REV.	X5	TITLE	USB TYPE C CONNECTOR	CHECKED	Michael.Qin
.X±0.38	.x °± 2°	SIZE		SHEET	2 OF 2	APPROVED	Weison.Lu
.XX±0.25	.xx ± 1°	A4					

MATERIAL		SCALE	1:1
DATE	2018.04.10	UNIT	MM
Amphenol Shouhmin Industry			